

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

are list	I believe I am ed below) of t	he subject i	al, first and s matter which RMATIC	h is cla	imed and	for which	ch a paten	t is sou	ght on the	he invent	ion entitle	ed .	or (if plura	al names	
the	specificat	ion of	which	x	s United S	i s States A	attach pplication	ed No. or	hereto PCT In	ternation	al Applica	was	filed	on	
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by any	I hereby state amendment re			nd unde	erstand the	e conten	its of the a	bove-id	lentified	specifica	ition, incli	uding the c	laims, as a	mended	
	I acknowled	ge the duty	to disclose	inform	ation whic	ch is ma	terial to p	atentab	ility as c	defined in	37 CFR	§1.56.			
have al	I hereby clain ate, or § 365(a so identified b the applicatio	) of any PC elow any fo	T internatio reign applic	nal app	olication wor patent o	/hich de	signates a	t least o	ne coun	try other t	han the U	nited State	s, listed be	low and	
Countr	у	A	Application No.			Filed (Day/Mo./Yr.)					(Yes/No) Priority Claimed				
Japan Japan						May 28, 1999 October 26, 1999					Yes Yes				
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